

Data Sheet

Description

The SJPZ-K28 is a power Zener diode designed for the protection of automotive electronic units, especially from the surge generated during load dump conditions and voltage transients induced by inductive loads.

Features

- V_Z------ 25 V to 31 V

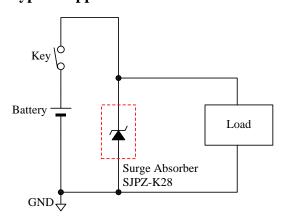
- AEC-Q101 Qualified
- Meets the Surge Protection Requirements in ISO7637-2 Standard (Pulse 1 to 3)
- High Reliability
- High Surge Capability
- Flammability UL94V-0 (Equivalent)
- RoHS Compliant

Applications

Protection of sensitive electronic equipment in passenger cars, trucks, vans, and buses:

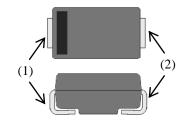
- Engine Control Units
- Electric Control Units
- Braking System
- Power Steering System
- Airbags
- Audio/Infotainment Equipment

Typical Application



Package

SJP





- (1) Cathode
- (2) Anode

Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit	Remarks
Power Dissipation ⁽¹⁾	P_{D}	Lead temperature, T _L ⁽²⁾	1	W	
DC Blocking Voltage	V_{DC}		20	V	
Peak Reverse Power	P_{RSM}	5 ms, single block pulse	50	W	
Junction Temperature	T_J		-40 to 150	°C	
Storage Temperature	T_{STG}		-40 to 150	°C	

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remarks
Forward Voltage Drop	V_{F}	$I_F = 1 A$	_	_	0.95	V	
Reverse Leakage Current	I_R	$V_R = 20 \text{ V}$	_	_	10	μΑ	
Breakdown Voltage	V_{Z}	$I_Z = 1 \text{ mA}$	25	_	31	V	
Breakdown Voltage Temperature Coefficient	r_Z	$I_Z = 1 \text{ mA}$	_	25	_	mV/°C	
Breakdown Region Equivalent Resistance	R_{Z}	$I_Z = 1 \text{ mA to } 10 \text{ mA}$	—	26		Ω	
Thermal Resistance	R _{th(J-L)}	(3)	_	20	_	°C/W	

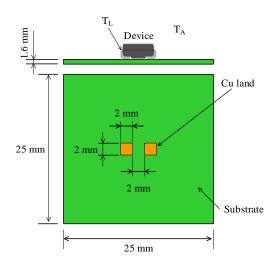


Figure 1. Lead Temperature Measurement Conditions

⁽¹⁾ See Figure 2. (2) See Figure 1.

 $^{^{(3)}}$ $R_{\text{th(J-L)}}$ is thermal resistance between junction and lead. Lead temperature is measured as shown in Figure 1.

Rating and Characteristics Curves

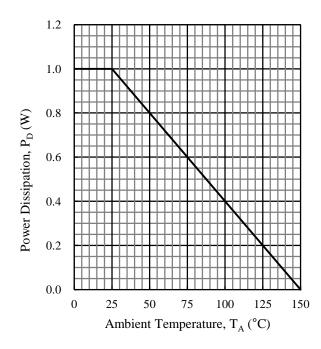


Figure 2. Power Dissipation Curve⁽⁴⁾

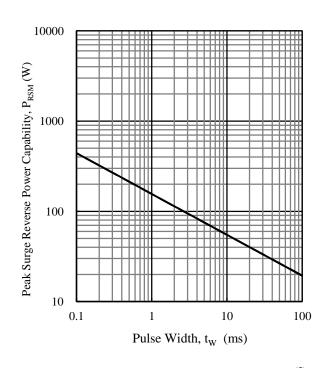


Figure 3. Peak Surge Reverse Power Capability⁽⁵⁾

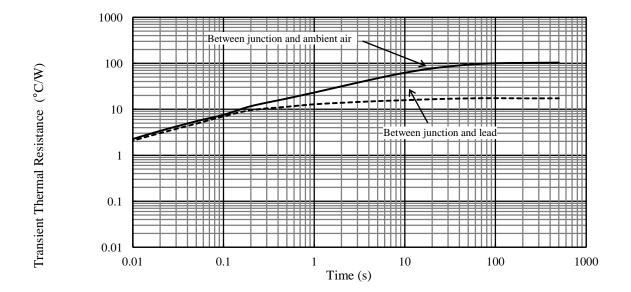


Figure 4. Typical Transient Thermal Resistance⁽⁶⁾

⁽⁴⁾ See Figure 1 for the measurement conditions.(5) The pulse is single block pulse.

⁽⁶⁾ Lead temperature is measured as shown in Figure 1.

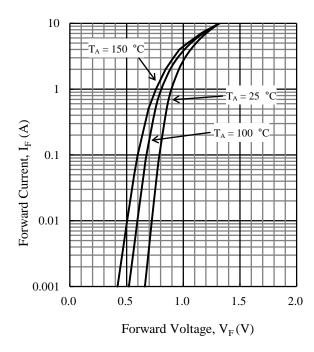


Figure 5. I_F-V_F Typical Characteristics

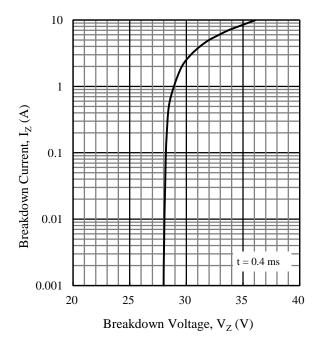


Figure 7. $I_Z - V_Z$ Typical Characteristics

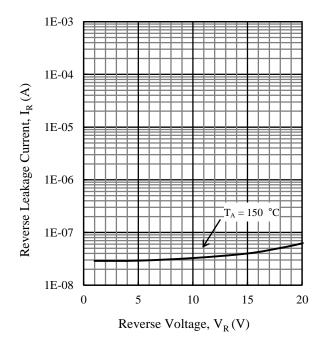
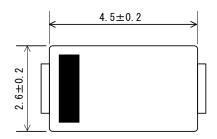


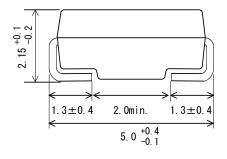
Figure 6. $I_R - V_R$ Typical Characteristics⁽⁷⁾

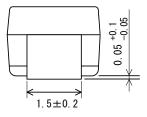
 $^{^{(7)}}$ I_R is less than 10 nA at 100 $\,\,^{\circ}\text{C}$ or less.

Physical Dimensions

• SJP Package







NOTES:

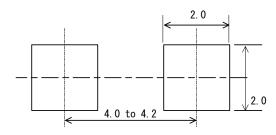
- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits:

Flow: 260 ± 5 °C / 10 ± 1 s, 2 times

Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the

body of the products.)MSL: JEDEC LEVEL1

• SJP Land Pattern Example



NOTE: Dimensions in millimeters

Marking Diagram

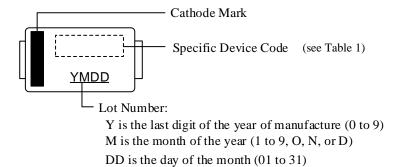


Table 1. Specific Device Code

Specific Device Code	Part Number		
ZK28	SJPZ-K28		

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